

# TD Powerchip TVSBDU0317180.0 3-Ch

#### **General description**

Unidirectional Electrostatic Discharge (ESD)/Electrical Overstress (EOS) protection device designed to protect one signal line from the damage caused by ESD and other transients.

#### **Features**

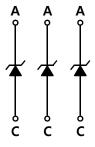
- · ESD protection of one line
- Low capacitance
- Suitable for a 3V signal line
- Low clamping Voltage :  $V_{CL} = 17.5V (8/20\mu s)$
- Low leakage current :  $I_{RM}$ = 87nA @ $V_{RWM}$  = 3.2V
- ESD protection (IEC 61000-4-2) : > 30kV
- IEC 61000-4-5 (surge);  $P_{PPM}$ = 183W

#### **Application**

- Computers and peripherals
- · Audio and video equipment
- · Cellular handsets and accessories
- 10/100/1000 Mbit/s Ethernet
- Portable electronics
- SIM card protection
- High-speed data lines



st4260\_PM06\_u550a\_gc2\_pd3s



**Device Schematic** 

#### **Maximum Ratings**

| Parameter             | Symbol           | Values     | Unit | Test Conditions                                |
|-----------------------|------------------|------------|------|--|
| ESD Withstand Voltage | V <sub>ESD</sub> | ±30        | kV   | IEC 61000-4-2(Contact)                         |
|                       |                  | ±30        | kV   | IEC 61000-4-2(Air)                             |
| Peak pulse power      | P <sub>PK</sub>  | 183        | W    | t <sub>p</sub> = 8/20μs                        |
| Peak pulse current    | Ірр              | 10.5       | А    | t <sub>p</sub> = 8/20µs                        |
| Peak pulse power      | P <sub>PK</sub>  | 395        | W    | t <sub>p</sub> = 8/20µs<br>2x parallel connect |
| Peak pulse current    | Ірр              | 21         | А    | t <sub>p</sub> = 8/20µs<br>2x parallel connect |
| Junction temperature  | Тј               | 150        | °C   |  |
| Storage temperature   | T <sub>stg</sub> | -55 to 150 | °C   |  |

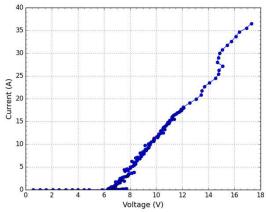


### **Electrical Characteristics**

| Parameter                | Symbol                                | Values  | Unit | Test Conditions  |
|--------------------------|---------------------------------------|---|------|--|
| Reverse Standoff Voltage | V <sub>RWM</sub>                      | 3.2   | V    | $I_R \le 1\mu A$   |
| Breakdown Voltage        | V <sub>BR</sub>                       | 5.0   | V    | $I_{R} = 0.1mA$  |
| Reverse Leakage Current  | I <sub>RM</sub>                       | 87  | nA   | V <sub>RWM</sub> = 3.2V  |
| Clamping Voltage(8/20µs) | v <sub>C</sub>                        | 17.5  | V    | Ipp = $10.5A$ , $t_p = 8/20 \mu s$                                     |
| Clamping Voltage(8/20µs) | v <sub>C</sub>                        | 18.8  | V    | $I_{\mathrm{PP}} = 21A, t_p = 8/20 \mu \mathrm{s}$ 2x parallel connect |
| Dynamic resistance       | R <sub>DYN</sub>                      | 0.3   | Ω    | TLP, t <sub>p</sub> =100ns   |
| Holding Voltage          | V <sub>h</sub>                        | 6.3   | V    | $I_{\text{TLP}} = 0.28A$   |
| BO Voltage               | V <sub>T1</sub>                       | 7.7   | V    | TLP, t <sub>p</sub> =100ns   |
| Limit Current            | I <sub>T2</sub>                       | >40<br>* Exceed measurement<br>limit over 40A | А    | TLP, t <sub>p</sub> =100ns   |
| Clamping Voltage(TLP)    |                                       | 6.9   | V    | $I_{\text{TLP}} = 1A$  |
|                          | \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ | 8.8   |      | $I_{TLP} = 8A$   |
|                          | V <sub>cl</sub>                       | 11.2  |      | $I_{\text{TLP}} = 16A$   |
|                          |                                       | 15.5  |      | $I_{TLP} = 32A$  |
| Diode Capacitance        | C.                                    | 31  | pF   | Reverse Bias=0V, f=1MHz  |
|                          | C <sub>d</sub>                        | 14  | pF   | Reverse Bias=2V, f=1MHz  |

# 8/20μs Pulse Waveform

# Transmission Line Pulsing(TLP) Plot



## Capacitance vs Reverse Voltage

